

Features

- Compliant with AEC-Q200 Rev-C Stress Test Qualification for Passive Components in Automotive Applications
- Compact design to save board space -1206 footprint
- Small size results in very fast time to react to fault events
- Symmetrical design

- Low profile
- RoHS compliant* and halogen free**



MF-NSMF Series - PTC Resettable Fuses

Electrical Characteristics

		V max. Volts	I max.	l _{hold}	I _{trip}	Resistance		Max. Time To Trip		Tripped Power Dissipation
	Model		Amps	Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C
				Hold	Trip	R _{Min} .	R _{1Max} .			Тур.
Γ	MF-NSMF012	30.0	10	0.12	0.29	1.35	8.50	1.0	0.20	0.4
Γ	MF-NSMF020	24.0	10	0.20	0.46	0.60	2.60	1.0	0.60	0.6
۲ſ	MF-NSMF020X***	30.0	60	0.20	0.40	0.60	3.30	1.0	0.60	0.6
Ï	MF-NSMF035	6.0	100	0.35	0.75	0.30	1.20	8.0	0.10	0.6
Γ	MF-NSMF035X****	16.0	20	0.35	0.75	0.30	1.40	3.5	0.14	0.6
Γ	MF-NSMF050	13.2	100	0.50	1.00	0.15	0.70	8.0	0.10	0.4
Γ	MF-NSMF075	6.0	100	0.75	1.50	0.10	0.40	8.0	0.10	0.4
[MF-NSMF110	6.0	100	1.10	2.20	0.06	0.20	8.0	0.10	0.6
Γ	MF-NSMF150	6.0	100	1.50	3.00	0.03	0.13	8.0	0.30	0.6
	MF-NSMF200	6.0	100	2.00	4.00	0.02	0.085	8.0	1.00	0.7

^{***}Features Multifuse® freeXpansion Design™ for MF-NSMF Series (TÜV pending) ****Features Multifuse® freeXpansion Design™ for MF-NSMF Series

Environmental Characteristics

Operating Temperature	40 °C to +85 °C	
Maximum Device Surface Temperature		
in Tripped State	125 °C	
Passive Aging	+85 °C, 1000 hours	±5 % typical resistance change
Humidity Aging	+85 °C, 85 % R.H. 1000 hours	±5 % typical resistance change
Thermal Shock	+85 °C to -40 °C, 20 times	±10 % typical resistance change
	MIL-STD-202, Method 215	
Vibration	MIL-STD-883C, Method 2007.1,	No change
	Condition A	•

Test Procedures And Requirements For Model MF-NSMF Series

Resistance	Test Conditions Verify dimensions and materials	 Rmin ≤ R ≤ R1max T ≤ max. time to trip (seconds) No trip No arcing or burning No arcing or burning
UL File Number TÜV Certificate Number	E174545 http://www.ul.com/ Follow link to Certifications, t	hen UL File No., enter E174545

^{*}RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

**Bourns follows the prevailing definition of "halogen free" in the industry. Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less;

(b) the Chlorine (CI) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (CI) content is 1500 ppm or less. Specifications are subject to change without notice.

Applications

- USB port protection USB 2.0, 3.0 & OTG
- Automotive electronic control modules
- HDMI 1.4 Source protection
- PC motherboards Plug and Play protection
- Mobile phones Battery and port protection
- PDAs / digital cameras
- Game console port protection

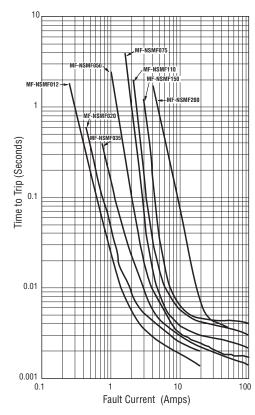
MF-NSMF Series - PTC Resettable Fuses

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Thermal Derating Chart - Ihold (Amps)

Model	Ambient Operating Temperature									
Widdei	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C	
MF-NSMF012	0.19	0.17	0.15	0.12	0.11	0.10	0.09	0.08	0.07	
MF-NSMF020	0.30	0.27	0.24	0.20	0.18	0.16	0.14	0.12	0.11	
MF-NSMF020X	0.30	0.27	0.24	0.20	0.18	0.16	0.14	0.12	0.10	
MF-NSMF035	0.51	0.46	0.40	0.35	0.30	0.27	0.24	0.22	0.18	
MF-NSMF035X	0.58	0.51	0.44	0.35	0.31	0.28	0.24	0.21	0.16	
MF-NSMF050	0.76	0.68	0.59	0.50	0.44	0.40	0.35	0.32	0.26	
MF-NSMF075	1.11	1.00	0.85	0.75	0.67	0.61	0.52	0.50	0.42	
MF-NSMF110	1.64	1.46	1.30	1.10	0.92	0.83	0.80	0.65	0.52	
MF-NSMF150	2.20	1.99	1.77	1.50	1.34	1.23	1.10	1.01	0.84	
MF-NSMF200	2.88	2.61	2.28	2.00	1.80	1.66	1.51	1.39	1.19	

Typical Time to Trip at 23 °C



The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

MF - NSMF 020 X - 2 Multifuse® Product Designator Series NSMF = 1206 Surface Mount Component

How to Order

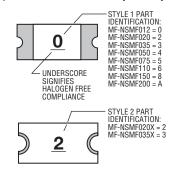
Hold Current, Ihold
012-200 (0.12 Amps - 2.00 Amps)
Options

= Standard
X = Multifuse® freeXpansion Design™
MF-NSMF Series

Packaged
Packaged per EIA 481-1
-2 = Tape and Reel

Typical Part Marking

Represents total content. Layout may vary.



BIWEEKLY DATE CODE WILL APPEAR ON THE PACKAGING LABEL: WEEK 1 AND 2 = A WEEK 51 AND 52 = Z

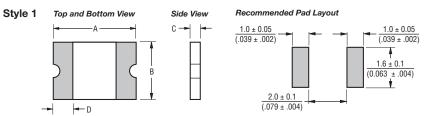
MF-NSMF Series - PTC Resettable Fuses

Product Dimensions

Medel	-	4	l	3			D	Ctyle
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Style
MF-NSMF012	3.00	3.40	1.40	1.80	0.70	1.10	0.25	1
IVII -INGIVII U12	(0.118)	(0.134)	(0.055)	(0.071)	(0.028)	(0.043)	(0.010)	<u>'</u>
MF-NSMF020	3.00	3.40	1.40	1.80	_0.48_	_0.85_	_0.25_	1
WII -140WII 020	(0.118)	(0.134)	(0.055)	(0.071)	(0.019)	(0.033)	(0.010)	'
MF-NSMF020X	3.00	3.40	_1.40_	1.80	_0.40_	0.85	0.25	2
IVII TVOIVII OZOX	(0.118)	(0.134)	(0.055)	(0.071)	(0.016)	(0.033)	(0.010)	
MF-NSMF035	3.00_	3.40	_1.40_	_1.80_	_0.48_	_0.85_	_0.25_	1
IVII TVOIVII 000	(0.118)	(0.134)	(0.055)	(0.071)	(0.019)	(0.033)	(0.010)	'
MF-NSMF035X	3.00_	3.40	1.40	1.80	_0.40_	0.85	0.25	2
IVII -INGIVII 000X	(0.118)	(0.134)	(0.055)	(0.071)	(0.016)	(0.033)	(0.010)	
MF-NSMF050	3.00_	3.40	_1.40_	_1.80_	_0.48_	0.85	0.25	1
IVII -INGIVII 000	(0.118)	(0.134)	(0.055)	(0.071)	(0.019)	(0.033)	(0.010)	'
MF-NSMF075	3.00	3.40	1.40	1.80	_0.40_	0.70	0.25	1
IVII -IVOIVII 075	(0.118)	(0.134)	(0.055)	(0.071)	(0.016)	(0.028)	(0.010)	'
MF-NSMF110	3.00	3.40	1.40	1.80	_0.40_	0.70	0.25	1
IVII -INGIVII 110	(0.118)	(0.134)	(0.055)	(0.071)	(0.016)	(0.028)	(0.010)	'
MF-NSMF150	3.00	3.40	1.40	1.80	_0.40_	0.70	0.25	4
IVII -INGIVII 130	(0.118)	(0.134)	(0.055)	(0.071)	(0.016)	(0.028)	(0.010)	'
MF-NSMF200	3.00	3.50	1.40	1.80	_0.70_	1.60	0.25	1
IVIII - I NOIVIII 200	(0.118)	(0.138)	(0.055)	(0.071)	(0.028)	(0.063)	(0.010)	'

Packaging: 3000 pcs. per reel.

MM DIMENSIONS: (INCHES)



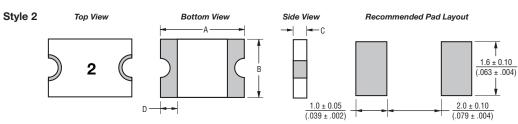
Terminal material:

Electroless Ni under immersion Au

Termination pad solderability: Standard Au finish: Meets ANSI/J-STD-002 Category 2.

Recommended Storage:

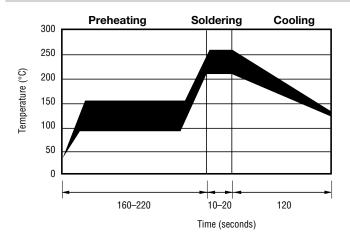
40 °C max./70 % RH max.



MF-NSMF Series - PTC Resettable Fuses

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Solder Reflow Recommendations

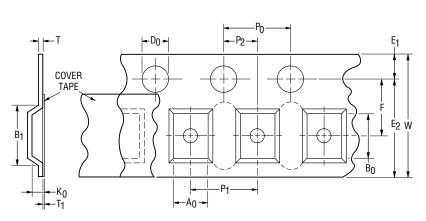


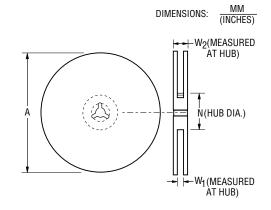
Notes:

- MF-NSMF models cannot be wave soldered. Please contact Bourns for hand soldering recommendations.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- · Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit, especially during hand soldering.
 Please refer to the Multifuse® Polymer PTC Soldering Recommendation guidelines.

MF-NSMF Series Tape and Reel Specifications

	MF-NSMF012 & MF-NSMF200	MF-NSMF020 ~ MF-NSMF050	MF-NSMF075 ~ MF-NSMF150	MF-NSMF020X & MF-NSMF035X
Tape Dimensions	per EIA 481-1	per EIA 481-1	per EIA 481-1	per EIA 481-1
W	8.0 ± 0.30	8.0 ± 0.30	8.0 ± 0.30	8.0 ± 0.30
	(0.315 ± 0.012)	(0.315 ± 0.012)	(0.315 ± 0.012)	(0.315 ± 0.012)
P ₀	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10
. 0	(0.157 ± 0.004)	(0.157 ± 0.004)	(0.157 ± 0.004)	(0.157 ± 0.004)
P ₁	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10
· I	(0.157 ± 0.004)	(0.157 ± 0.004)	(0.157 ± 0.004)	(0.157 ± 0.004)
P ₂	2.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05
. 2	(0.079 ± 0.002)	(0.079 ± 0.002)	(0.079 ± 0.002)	(0.079 ± 0.002)
A_0	1.90 ± 0.10	1.90 ± 0.10	1.90 ± 0.10	1.90 ± 0.10
, 10 	(0.075 ± 0.004)	(0.075 ± 0.004)	(0.075 ± 0.004)	(0.075 ± 0.004)
B ₀	3.50 ± 0.10	3.45 ± 0.10	3.45 ± 0.10	3.55 ± 0.10
	(0.138 ± 0.004)	(0.136 ± 0.004)	(0.136 ± 0.004)	(0.140 ± 0.004)
B ₁ max.	4.35 (0.171)	4.35 (0.171)	4.35 (0.171)	$\frac{4.35}{(0.171)}$
	,	, ,	,	
D_0	$\frac{1.5 + 0.10/-0.0}{(0.059 + 0.004/-0)}$			
	3.5 ± 0.05	3.5 ± 0.05	3.5 ± 0.05	3.5 ± 0.05
F	(0.138 ± 0.002)	$\frac{0.05 \pm 0.002}{(0.138 \pm 0.002)}$	$\frac{0.13 \pm 0.002}{(0.138 \pm 0.002)}$	$\frac{0.02 \pm 0.002}{(0.138 \pm 0.002)}$
	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10
E ₁	$\overline{(0.069 \pm 0.004)}$	$\overline{(0.069 \pm 0.004)}$	$\overline{(0.069 \pm 0.004)}$	(0.069 ± 0.004)
Es min	6.25	6.25	6.25	6.25
E ₂ min.	(0.246)	(0.246)	(0.246)	(0.246)
T max.	0.6	0.6	0.6	0.6
I IIIax.	(0.024)	(0.024)	(0.024)	$\overline{(0.024)}$
T ₁ max.	0.1	0.1	0.1	0.1
I I IIIax.	(0.004)	(0.004)	(0.004)	(0.004)
K ₀	1.35 ± 0.10	1.04 ± 0.10	0.85 ± 0.10	0.80 ± 0.10
	(0.053 ± 0.004)	(0.041 ± 0.004)	(0.033 ± 0.004)	(0.032 ± 0.004)
Leader min.	390	_390	390	_ 390
Leader IIIIII.	(15.35)	(15.35)	(15.35)	(15.35)
Trailer min.	_160	_160	_160_	_160_
	(6.30)	(6.30)	(6.30)	(6.30)
Reel Dimensions				
A max.	185	185	185	185
	(7.28)	(7.28)	(7.28)	(7.28)
N min.	_50	_ 50	50	50
IN HIMIG.	(1.97)	(1.97)	(1.97)	(1.97)
W ₁	8.4 + 1.5/-0.0	8.4 + 1.5/-0.0	8.4 + 1.5/-0.0	8.4 + 1.5/-0.0
ννη 	(0.331 + 0.059/-0.0)	(0.331 + 0.059/-0.0)	(0.331 + 0.059/-0.0)	(0.331 + 0.059/-0.0)
W ₂ max.	_14.4_	14.4	_14.4_	_14.4_
**2 max.	(0.567)	(0.567)	(0.567)	(0.567)





Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.